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Attorney Docket No.: A8067/T51700
AMAT No.: 008067/DSM/HDP/CVD/JPFEIFER
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Hemant P. Mungekar et al.

Application No.: 10/660,813

Filed: September 12, 2003

For: REACTIVE ION ETCHING FOR SEMICONDUCTOR DEVICE FEATURE TOPOGRAPHY MODIFICATION

Customer No.: 57385

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 Confirmation No. 7055

Examiner: McDonald, Rodney Glenn

Technology Center/Art Unit: 1753

AMENDMENT

Sir:

In response to the Office Action mailed July 19, 2006, please enter the following amendments and remarks:

A Listing of Claims begins on page 2 of this paper.

Remarks begin on page 7 of this paper.